L Number	Hits		DB	Time stamp
14	361	324/755.ccls. and (chip or die)	USPAT;	2002/10/22 12:27
			US-PGPUB;	
			EPO; JPO; DERWENT;	
			IBM TDB	
15	292	(324/755.ccls. and (chip or die)) and	USPAT;	2002/10/22 13:03
	232	(@ad<20000223)	US-PGPUB;	
		(EPO; JPO;	
			DERWENT;	
			IBM_TDB	
16	18	(324/755.ccls. and (chip or die)) and	USPAT;	2002/10/22 12:38
		(conduct\$3 near elastomer)	US-PGPUB;	
			EPO; JPO; DERWENT;	
			IBM TDB	
17	29	conductive with (carbon near elastomer)	USPAT;	2002/10/22 13:31
1 /	2.9	Conductive with (carbon hear craseomer)	US-PGPUB;	2002, 10, 22 10.01
			EPO; JPO;	
			DERWENT;	l :
			IBM_TDB	
18	118		USPĀT;	2002/10/22 13:34
		nickel or silver or steel or au or ag or	US-PGPUB;	i
		ni)	EPO; JPO;	
			DERWENT; IBM TDB	
1.0	49	((conductive near elastomer) with (gold or	USPAT;	2002/10/22 12:51
19	49	nickel or silver or steel or au or ag or	US-PGPUB;	2002/10/22 12:51
ļ		ni)) and (chip or die)	EPO; JPO;	
İ		liff, and temp of are,	DERWENT;	
			IBM TDB	
21	65	((conductive near elastomer) with (carbon	USPĀT;	2002/10/22 13:47
		or gold or nickel or silver or steel or au	US-PGPUB;	
		or ag or ni)) and (test or burn or kgd)	EPO; JPO;	
			DERWENT;	
		(//) this same alastomen with (sombon	IBM_TDB USPAT;	2002/10/22 13:16
22	53		USPAT; US-PGPUB;	2002/10/22 13:10
		or gold or nickel or silver or steel or au or ag or ni)) and (test or burn or kgd))	EPO; JPO;	
		and (@ad<20000223)	DERWENT;	
		and (cad 2000 blas)	IBM TDB	
24	20	((conductive near elastomer) with (carbon	USPAT;	2002/10/22 13:19
		or gold or nickel or silver or steel or au		•
		or ag or ni)) and 324/\$.ccls.	EPO; JPO;	
			DERWENT;	i
		// lating and all and a second and the / combon	IBM_TDB USPAT;	2002/10/22 13:21
25	2	((conductive near elastomer) with (carbon or gold or nickel or silver or steel or au	US-PGPUB;	2002/10/22 15.21
		or ag or ni)) with (lid or cap or package)	EPO; JPO;	
		or ag or mr, with the or cap or package,	DERWENT;	
			IBM TDB	
26	2		USPĀT;	2002/10/22 13:21
	_	or gold or nickel or silver or steel or au	US-PGPUB;	
		or ag or ni)) with (lid or cap or package	EPO; JPO;	
		or head)	DERWENT;	
			IBM_TDB	2002/10/22 12:25
23	18		USPAT;	2002/10/22 13:25
			US-PGPUB; EPO; JPO;	
			DERWENT;	
			IBM TDB	
20	240	(conductive near elastomer) with (carbon	USPAT;	2002/10/22 13:28
	2.0	or gold or nickel or silver or steel or au	US-PGPUB;	
		or ag or ni)	EPO; JPO;	
			DERWENT;	1
			IBM_TDB	2002/10/22 12:20
27	2248	1 '	USPAT;	2002/10/22 13:30
		burn or kgd)	US-PGPUB; EPO; JPO;	1
			DERWENT;	
			IBM TDB	
			TDM IND	

28	519	((variable adj resistance) and (test or	USPAT;	2002/10/22 13:32
20	313	burn or kgd)) and (chip or die)	US-PGPUB;	
		bull of kgu/, and (only of aro)	EPO; JPO;	
			DERWENT;	
			IBM TDB	
29	70	((variable adj resistance) and (test or	USPAT;	2002/10/22 13:32
29	/0	burn or kgd)) and elastomer	US-PGPUB;	
		built of kgu// and clastomer	EPO; JPO;	1
			DERWENT;	
			IBM TDB	:
20	0	(chip or die) near((conductive near	USPAT;	2002/10/22 13:36
30	0	elastomer) with (gold or nickel or silver	US-PGPUB;	, 2002, 10, 22 20.00
		or steel or au or ag or ni))	EPO; JPO;	
		of steel of ad of ag of hit/	DERWENT;	4
			IBM TDB	t
31	6	(chip or die) with((conductive near	USPĀT;	2002/10/22 13:46
31		elastomer) with (gold or nickel or silver	US-PGPUB;	
		or steel or au or ag or ni))	EPO; JPO;	ŀ
		or steer or an or ag or mr/	DERWENT;	
			IBM TDB	,
32	38	((conductive near elastomer) with (carbon	USPAT;	2002/10/22 13:41
32	30	or gold or nickel or silver or steel or au	US-PGPUB;	
		or ag or ni)) and package	EPO; JPO;	
		or ag or mr/, and package	DERWENT;	
			IBM TDB	
33	87	(chip or die) with (conductive near	USPAT;	2002/10/22 13:46
"		elastomer)	US-PGPUB;	
		CECO COMOL /	EPO; JPO;	
			DERWENT;	
			IBM TDB	
34	26	((chip or die) with (conductive near	USPAT;	2002/10/22 13:48
1 34	20	elastomer)) and (test or burn or kgd)	US-PGPUB;	1
	1	Ciabonici, / and (cobe of warm of nga/	EPO; JPO;	:
			DERWENT;	•
			IBM TDB	•